



SGM4684

Chip Scale Packaging, Low-Voltage 0.4Ω, Dual, SPDT Analog Switch

GENERAL DESCRIPTION

The SGM4684 is a dual, low on-resistance, low voltage, bidirectional, single-pole/double-throw (SPDT) CMOS analog switch designed to operate from a single 1.8V to 5.5V power supply. Targeted applications include battery powered equipment that benefit from low R_{ON} (0.4Ω) and fast switching speeds ($t_{ON} = 25ns$, $t_{OFF} = 28ns$).

The on resistance profile is very flat over the full analog signal range. This ensures excellent linearity and low distortion when switching audio signals.

The SGM4684 is a committed dual single-pole/double-throw (SPDT) that consist of two normally open (NO) and two normally close (NC) switches. This configuration can be used as a dual 2-to-1 multiplexer.

SGM4684 is available in a 10-ball Chip Scale Packaging (CSP).

APPLICATIONS

Battery-powered, Handheld, and Portable Equipment

Cellular/Mobile Phones

Laptops, Notebooks, Palmtops

Communication Systems

Sample-and-Hold Circuits

Audio Signal Routing

Audio and Video Switching

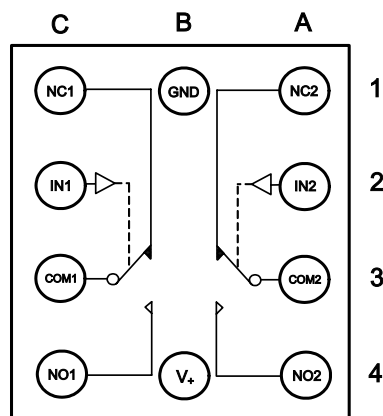
Portable Test and Measurement

Medical Equipment

FEATURES

- **Low Voltage Operation:** 1.8V to 5.5V
- **Low On-Resistance:** 0. 4Ω (TYP)
- **Low On-Resistance Flatness**
- **-3dB Bandwidth:** 13MHz
- **Fast Switching Times**
 t_{ON} 25ns
 t_{OFF} 28ns
- **Rail-to-Rail Operation**
- **Typical Power Consumption (<0.01μW)**
- **TTL/CMOS Compatible**
- **Chip Scale Packaging**

PIN CONFIGURATION (TOP VIEW)



FUNCTION TABLE

LOGIC	NC1, NC2	NO1, NO2
0	ON	OFF
1	OFF	ON



ORDERING INFORMATION

MODEL	PIN-PACKAGE	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER	PACKAGE MARKING	PACKAGE OPTION
SGM4684	CSP-10	-40°C to +125°C	SGM4684XG/TR	4684XG	Tape and Reel, 3000

ABSOLUTE MAXIMUM RATINGS

V₊ to GND.....-0.3V to 6V
 Analog, Digital voltage range ⁽¹⁾..... -0.3V to (V₊) + 0.3V
 Continuous Current NO, NC, or COM.....±300mA
 Peak Current NO, NC, or COM ±500mA
 Operating Temperature Range.....-40°C to +125°C
 Junction Temperature.....150°C

Storage Temperature.....-65°C to +150°C
 Lead Temperature (soldering, 10s).....260°C
 ESD Susceptibility
 HBM.....2000V
 MM.....400V

Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

(1) Signals on NC, NO, or COM or IN exceeding V₊ will be clamped by internal diodes. Limit forward diode current to maximum current ratings.

CAUTION

This integrated circuit can be damaged by ESD if you don't pay attention to ESD protection. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

PIN DESCRIPTION

NAME	FUNCTION
V ₊	Power supply.
GND	Ground
IN1, IN2	Digital control pin to connect the COM terminal to the NO or NC terminals.
COM1, COM2	Common terminal.
NO1, NO2	Normally-open terminal.
NC1, NC2	Normally-closed terminal.

Note: NO, NC and COM terminals may be an input or output.

ELECTRICAL CHARACTERISTICS(V₊ = +5V ± 10%, GND = 0V, T_A = -40°C to +125°C. Typical values are at T_A = +25°C, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	SGM4684			
			+25°C	-40°C to +125°C	UNITS	MIN/MAX
ANALOG SWITCH						
Analog Signal Range	V _{NO} , V _{NC} , V _{COM}			0	V	MIN
				V ₊	V	MAX
On-Resistance	R _{ON}	0 ≤ V _{NO} or V _{NC} ≤ V ₊ , I _{COM} = -10mA, Test Circuit 1	0.4		Ω	TYP
			0.6	1.1	Ω	MAX
On-Resistance Match Between Channels	ΔR _{ON}	0 ≤ V _{NO} or V _{NC} ≤ V ₊ , I _{COM} = -10mA, Test Circuit 1	0.04		Ω	TYP
			0.08	0.12	Ω	MAX
On-Resistance Flatness	R _{FLAT(ON)}	0 ≤ V _{NO} or V _{NC} ≤ V ₊ , I _{COM} = -10mA, Test Circuit 1	0.1		Ω	TYP
			0.15	0.4	Ω	MAX
LEAKAGE CURRENTS						
Source OFF Leakage Current	I _{NC(OFF)} , I _{NO(OFF)}	V _{NO} or V _{NC} = 4.5V/1V, V _{COM} = 1V/4.5V, V ₊ = +5.5V ,Test Circuit 2	±4		nA	TYP
			±10	±1000	nA	MAX
Channel ON Leakage Current	I _{NC(ON)} , I _{NO(ON)} , I _{COM(ON)}	V _{NO} or V _{NC} = V _{COM} = 1V or 4.5V, V ₊ = +5.5V , Test Circuit 3	±4		nA	TYP
			±10	±1000	nA	MAX
DIGITAL INPUTS						
Input High Voltage	V _{INH}			2.4	V	MIN
Input Low Voltage	V _{INL}			0.8	V	MAX
Input Current	I _{INL} or I _{INH}	V _{IN} = V _{INH} or V _{INL}	±0.01		μA	TYP
			±0.1	±1	μA	MAX
DYNAMIC CHARACTERISTICS						
Turn-On Time	t _{ON}	V _{NO} or V _{NC} = 3V, R _L = 300Ω, C _L = 35pF, Test Circuit 4	25		ns	TYP
Turn-Off Time	t _{OFF}	V _{NO} or V _{NC} = 3V, R _L = 300Ω, C _L = 35pF, Test Circuit 4	28		ns	TYP
Charge Injection	Q	C _L = 1.0nF, V _G = 0V, R _G = 0Ω, Test Circuit 5	3		pC	TYP
Break-Before-Make Time Delay	t _D	V _{NO1} or V _{NC1} = V _{NO2} or V _{NC2} = 3V, R _L = 300Ω, C _L = 35pF, Test Circuit 6	10		ns	TYP
Off Isolation	O _{ISO}	R _L = 50Ω, C _L = 5pF, Test Circuit 7	f = 100kHz	-70	dB	TYP
			f = 10kHz	-85	dB	TYP
Total Harmonic Distortion	THD	f = 20Hz to 20kHz, V _{COM} = 3.5V _{P-P} , R _L = 600Ω, C _L = 50pF	0.07		%	TYP
Channel-to-Channel Crosstalk	X _{TALK}	R _L = 50Ω, C _L = 5pF, Test Circuit 8	f = 100kHz	-100	dB	TYP
			f = 10kHz	-105	dB	TYP
-3dB Bandwidth	BW	R _L = 50Ω, C _L = 5pF, Test Circuit 9	13		MHz	TYP
Source OFF Capacitance	C _{NC(OFF)} , C _{NO(OFF)}		94		pF	TYP
Channel ON Capacitance	C _{NC(ON)} , C _{NO(ON)} , C _{COM(ON)}		450		pF	TYP
POWER REQUIREMENTS						
Power Supply Current	I ₊	V ₊ = +5.5V, V _{IN} = 0V or 5V	0.001		μA	TYP
				1	μA	MAX

Specifications subject to changes without notice.

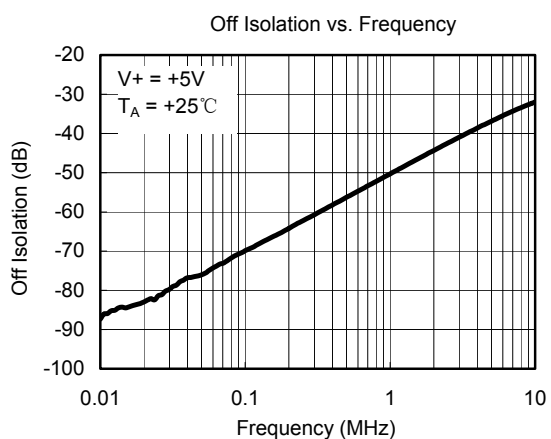
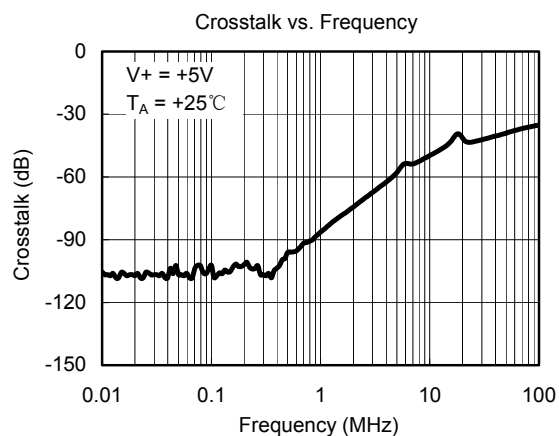
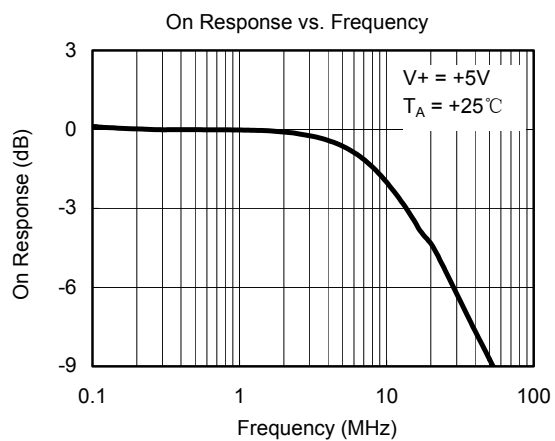
ELECTRICAL CHARACTERISTICS

(V₊ = +3V ± 10%, GND = 0V, T_A = -40°C to +125°C, Typical values are at T_A = +25°C, unless otherwise noted.)

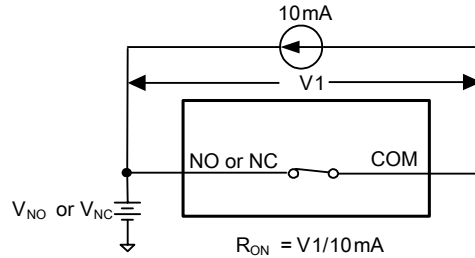
PARAMETER	SYMBOL	CONDITIONS	SGM4684			
			+25°C	-40°C to +125°C	UNITS	MIN/ MAX
ANALOG SWITCH						
Analog Signal Range	V _{NO} , V _{NC} , V _{COM}			0	V	MIN
				V ₊	V	MAX
On-Resistance	R _{ON}	0 ≤ V _{NO} or V _{NC} ≤ V ₊ , I _{COM} = -10mA, Test Circuit 1	0.6		Ω	TYP
			1.0	1.3	Ω	MAX
On-Resistance Match Between Channels	ΔR _{ON}	0 ≤ V _{NO} or V _{NC} ≤ V ₊ , I _{COM} = -10mA, Test Circuit 1	0.05		Ω	TYP
			0.1	0.13	Ω	MAX
On-Resistance Flatness	R _{FLAT(ON)}	0 ≤ V _{NO} or V _{NC} ≤ V ₊ , I _{COM} = -10mA, Test Circuit 1	0.25		Ω	TYP
			0.3	0.4	Ω	MAX
LEAKAGE CURRENTS						
Source OFF Leakage Current	I _{NC(OFF)} , I _{NO(OFF)}	V _{NO} or V _{NC} = 3V/1V, V _{COM} = 1V/3V, V ₊ = +3.3V ,Test Circuit 2	±5		nA	TYP
			±11	±1000	nA	MAX
Channel ON Leakage Current	I _{NC(ON)} , I _{NO(ON)} , I _{COM(ON)}	V _{NO} or V _{NC} = V _{COM} = 1V or 3V, V ₊ = +3.3V , Test Circuit 3	±5		nA	TYP
			±11	±1000	nA	MAX
DIGITAL INPUTS						
Input High Voltage	V _{INH}			2.0	V	MIN
Input Low Voltage	V _{INL}			0.4	V	MAX
Input Current	I _{INL} or I _{INH}	V _{IN} = V _{INH} or V _{INL}	±0.01		μA	TYP
			±0.1	±1	μA	MAX
DYNAMIC CHARACTERISTICS						
Turn-On Time	t _{ON}	V _{NO} or V _{NC} = 2V, R _L = 300Ω, C _L = 35pF, Test Circuit 4	30		ns	TYP
Turn-Off Time	t _{OFF}	V _{NO} or V _{NC} = 2V, R _L = 300Ω, C _L = 35pF, Test Circuit 4	32		ns	TYP
Charge Injection	Q	C _L = 1.0nF, V _G = 0V, R _G = 0Ω, Test Circuit 5	5		pC	TYP
Break-Before-Make Time Delay	t _D	V _{NO1} or V _{NC1} = V _{NO2} or V _{NC2} = 2V, R _L = 300Ω, C _L = 35pF, Test Circuit 6	11		ns	TYP
Off Isolation	O _{ISO}	R _L = 50Ω, C _L = 5pF, Test Circuit 7	f = 100kHz	-70	dB	TYP
			f = 10kHz	-85	dB	TYP
Total Harmonic Distortion	THD	f = 20Hz to 20kHz, V _{COM} = 2V _{P-P} , R _L = 600Ω, C _L = 50pF	0.065		%	TYP
Channel-to-Channel Crosstalk	X _{TALK}	R _L = 50Ω, C _L = 5pF, Test Circuit 8	f = 100kHz	-100	dB	TYP
			f = 10kHz	-105	dB	TYP
-3dB Bandwidth	BW	R _L = 50Ω, C _L = 5pF, Test Circuit 9	13		MHz	TYP
Source OFF Capacitance	C _{NC(OFF)} , C _{NO(OFF)}		94		pF	TYP
Channel ON Capacitance	C _{NC(ON)} , C _{NO(ON)} , C _{COM(ON)}		450		pF	TYP
POWER REQUIREMENTS						
Power Supply Current	I ₊	V ₊ = +3.3V, V _{IN} = 0V or 3V	0.001		μA	TYP
				1	μA	MAX

Specifications subject to changes without notice.

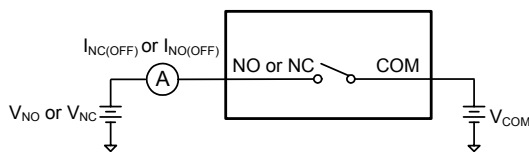
TYPICAL PERFORMANCE CHARACTERISTICS



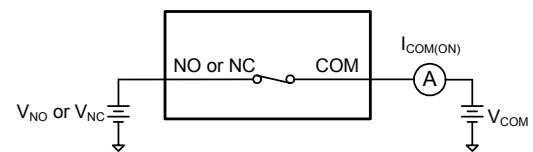
TEST CIRCUITS



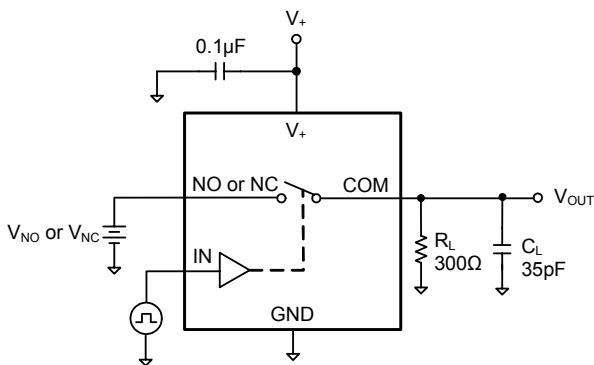
Test Circuit 1. On Resistance



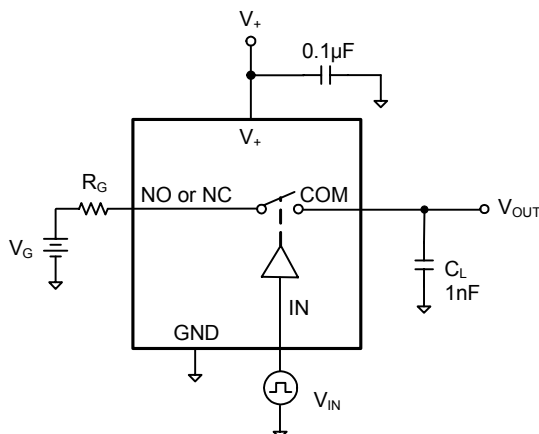
Test Circuit 2. Off Leakage



Test Circuit 3. On Leakage

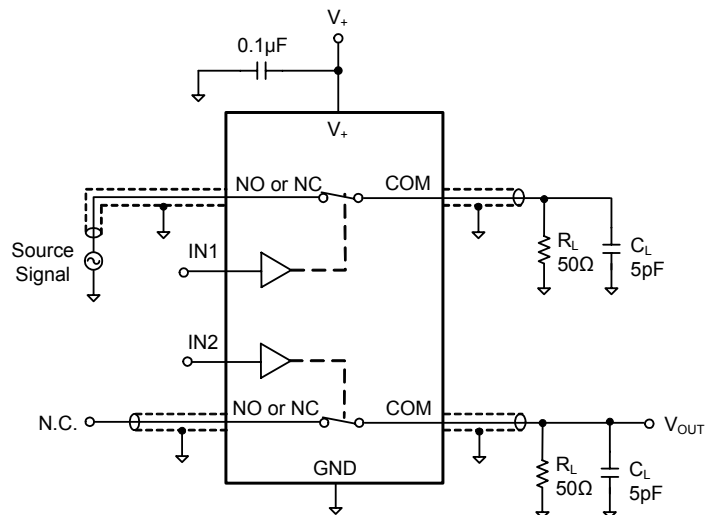
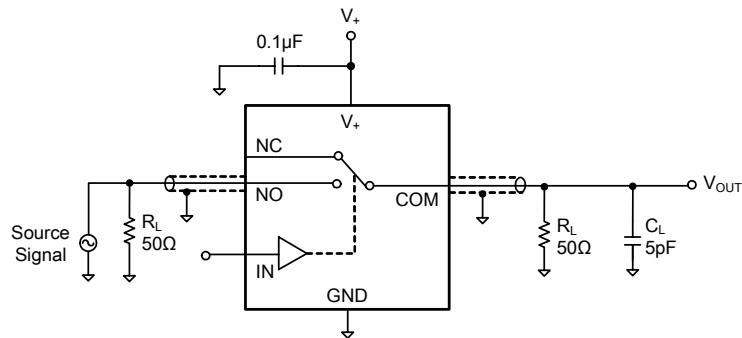
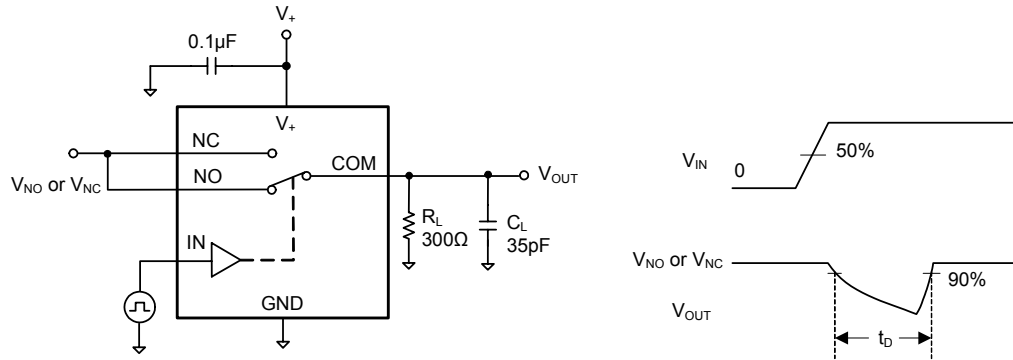


Test Circuit 4. Switching Times



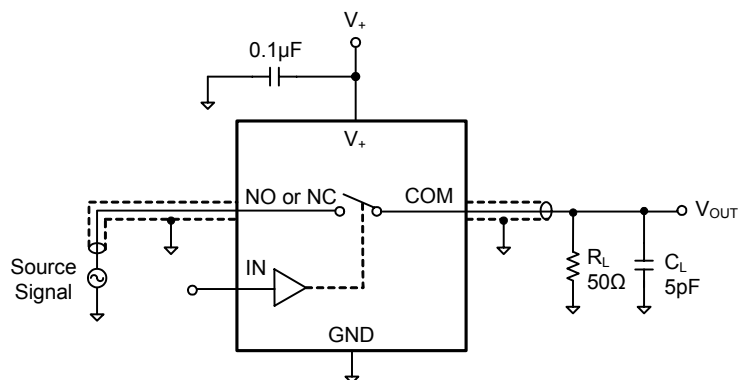
Test Circuit 5. Charge Injection

TEST CIRCUITS (Cont.)



$$\text{Channel To Channel Crosstalk} = -20 \times \log \frac{V_{NO \text{ or } V_{NC}}}{V_{OUT}}$$

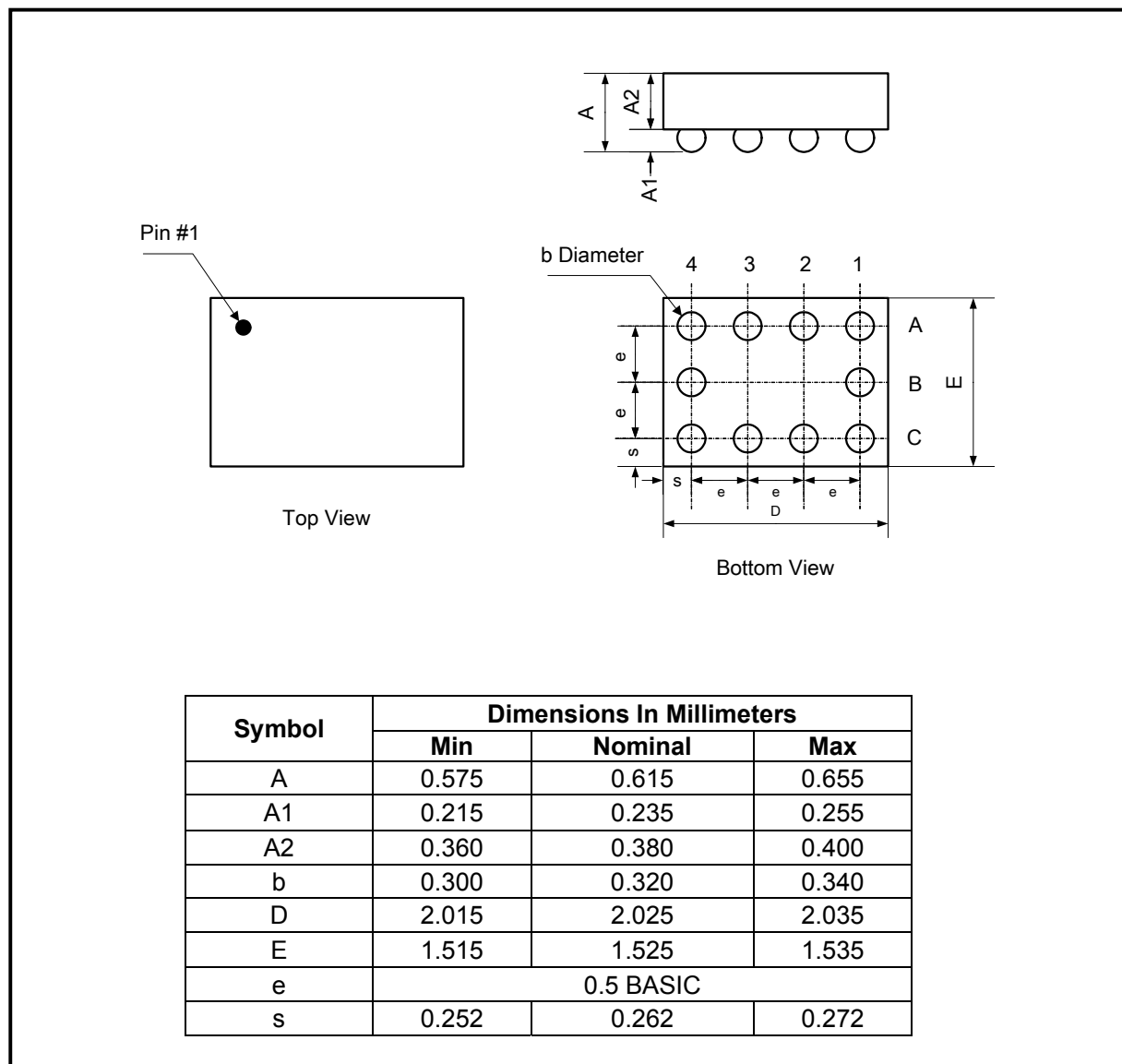
TEST CIRCUITS (Cont.)



Test Circuit 9. -3dB Bandwidth

PACKAGE OUTLINE DIMENSIONS

CSP-10



12/2008 REV. D

SGMICRO is dedicated to provide high quality and high performance analog IC products to customers. All SGMICRO products meet the highest industry standards with strict and comprehensive test and quality control systems to achieve world-class consistency and reliability.

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